

5-Line ESD Protection Diode Array in LLP75-6A

RoHS

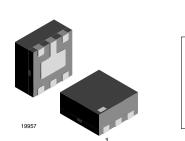
COMPLIANT

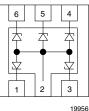
GREEN

Features

/ISHA

- Ultra compact LLP75-6A package
- 5-line ESD-protection
- Surge immunity acc. IEC 61000-4-5 I_{PPM} > 12 A
- Low leakage current I_R < 1 μA
- ESD-immunity acc. IEC 61000-4-2 ± 30 kV contact discharge ± 30 kV air discharge
- Working voltage range V_{RWM} = 5 V
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC





Marking (example only)



Dot = Pin 1 marking XX = Date code YY = Type code (see table below)

Ordering Information

| Device name | Device name Ordering code | | Minimum order quantity | | |
|-------------|---------------------------|------|------------------------|--|--|
| GMF05C-HS3 | GMF05C-HS3-GS08 | 3000 | 15000 | | |

Package Data

| Device name | Package name | Type code | Weight | t Molding compound Moisture sensitivity level Solder flammability rating | | Soldering conditions |
|-------------|-----------------|--------------|--------|--|-----------------------------------|--------------------------|
| GMF05C-HS3 | LLP75-6A | F5 | 5.2 mg | UL 94 V-0 | MSL level 1 (according J-STD-020) | 260 °C/10 s at terminals |

* Please see document "Vishay Green and Halogen-Free Definitions (5-2008)" http://www.vishay.com/doc?99902

GMF05C-HS3

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Absolute Maximum Ratings

| Rating | Test condition | | | Value | Unit |
|-----------------------|--|-------------------|------------------|---------------|------|
| Peak pulse current | BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2); acc. IEC 61000-4-5; t _p = 8/20 μs; single shot | | | 12 | А |
| Peak pulse power | BiAs-mode: each input (pin 1; 3 - pin 6) to ground (p acc. IEC 61000-4-5; $t_p = 8/20 \mu$ s; single shot | P _{PP} | 200 | W | |
| ESD immunity | acc. IEC61000-4-2; 10 pulses BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2) | contact discharge | V _{ESD} | ± 30 | kV |
| | | air discharge | V_{ESD} | ± 30 | kV |
| Operating temperature | Junction temperature | | | - 55 to + 125 | °C |
| Storage temperature | | | T _{STG} | - 55 to + 150 | °C |

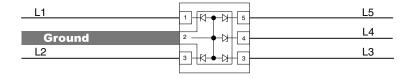
BiAs-Mode (5-line Bidirectional Asymmetrical protection mode)

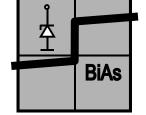
With the **GMF05C-HS3** up to 5 signal- or data-lines (L1 - L5) can be protected against voltage transients. With pin 2 connected to ground and pin 1; 3 up tp pin 6 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified **M**aximum **R**everse **W**orking **V**oltage (**V**_{**RWM**}) the protection diode between data line and ground offer a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the break through voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the **BR**eakthrough Voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection device.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction of the protection diode. The low Forward Voltage (V_F) clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the **GMF05C-HS3** clamping behaviour is **<u>Bi</u>**directional and <u>Asymmetrical</u> (**BiAs**).







Electrical Characteristics

Ratings at 25 °C, ambient temperature unless otherwise specified

GMF05C-HS3

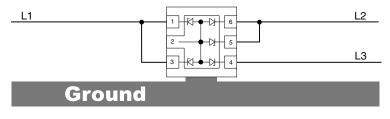
BiAs mode: each input (pin 1; 3 - pin 6) to ground (pin 2)

| Parameter | Test conditions/remarks | Symbol | Min. | Тур. | Max. | Unit |
|---------------------------|--|------------------|------|-------|------|-------|
| Protection paths | number of line which can be protected | N lines | | | 5 | lines |
| Reverse working voltage | at I _R = 1 μA | V _{RWM} | 5 | | | V |
| Reverse current | at $V_{R} = V_{RWM} = 5 V$ | I _R | | < 0.1 | 1 | μA |
| Reverse breakdown voltage | at I _R = 1 mA | V _{BR} | 6 | | 8 | V |
| Reverse clamping voltage | at I _{PP} = 12 A acc. IEC 61000-4-5 | V _C | | | 12.5 | V |
| | at I _{PP} = 1 A acc. IEC 61000-4-5 | V _C | | 7.8 | 9.5 | V |
| Forward clamping voltage | at I _F = 12 A acc. IEC 61000-4-5 | V _F | | | 5.5 | V |
| | at I _{PP} = 1 A acc. IEC 61000-4-5 | V _F | | 1.5 | | V |
| Capacitance | at $V_R = 0$ V; f = 1 MHz | CD | | 126 | 150 | pF |
| | at $V_R = 2.5 V$; f = 1 MHz | CD | | 76 | | pF |

If a higher surge current or **P**eak **P**ulse **current** (**I**_{**PP**}) is needed, some protection diodes in the **GMF05C-HS3** can also be used in parallel in order to "multiply" the performance.

If two diodes are switched in parallel you get

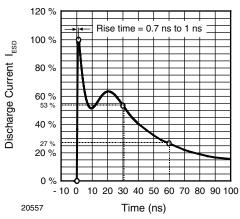
- double surge power = double peak pulse current (2 x I_{PPM})
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line **C**apacitance (2 x **C**_D)
- double Reverse leakage current (2 x I_R)

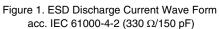


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Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified





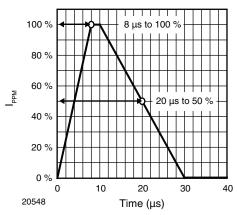


Figure 2. 8/20 µs Peak Pulse Current Wave Form (acc. IEC 61000-4-5)

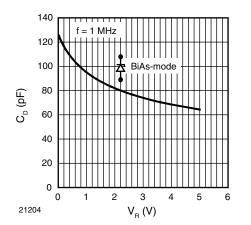


Figure 3. Typical Capacitance C_{D} vs. Reverse Voltage V_{R}



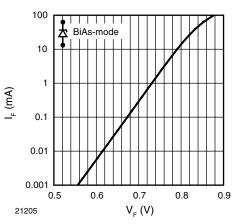


Figure 4. Typical Forward Current I_F vs. Forward Voltage V_F

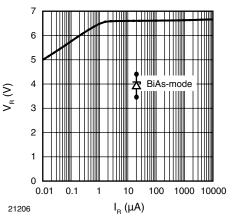


Figure 5. Typical Reverse Voltage $\rm V_R$ vs. Reverse Current $\rm I_R$

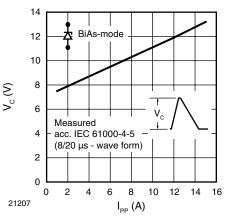


Figure 6. Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}



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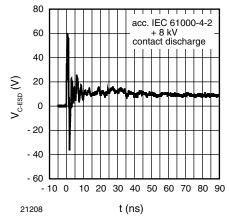


Figure 7. Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

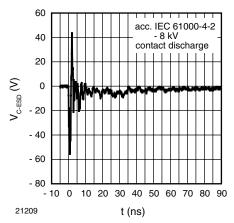
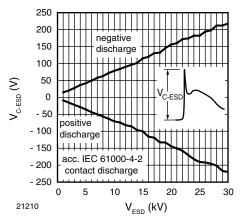
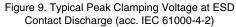


Figure 8. Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)



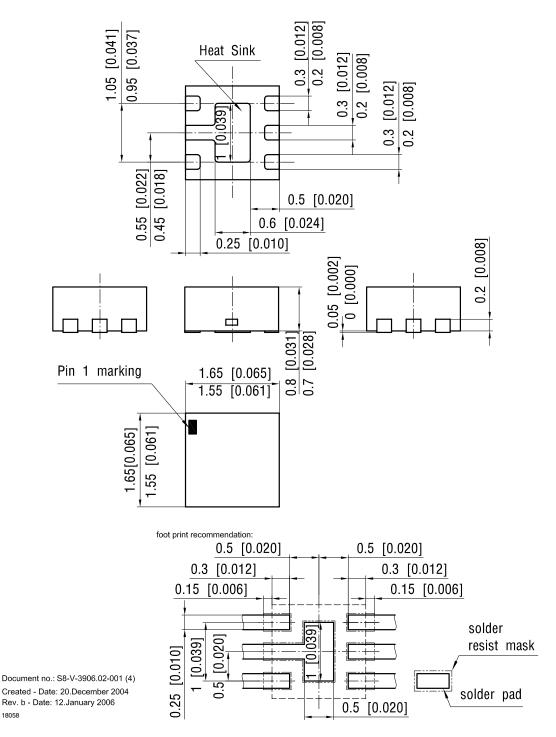


GMF05C-HS3



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Package Dimensions in millimeters (inches): LLP75-6A





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- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

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- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

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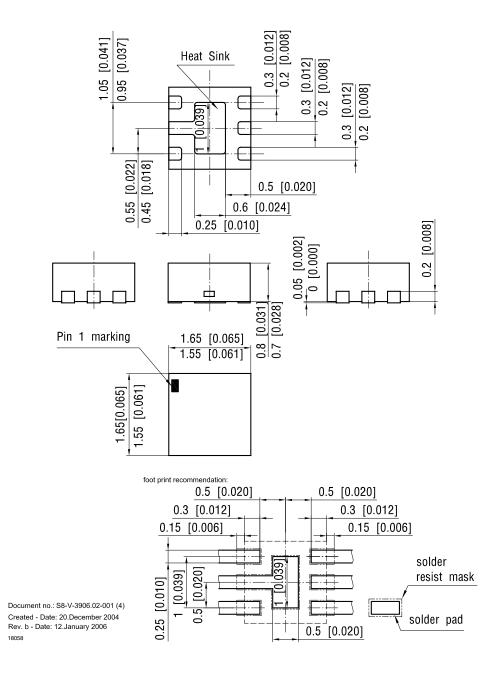
Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



LLP75-6A

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Package Dimensions in mm (Inches)

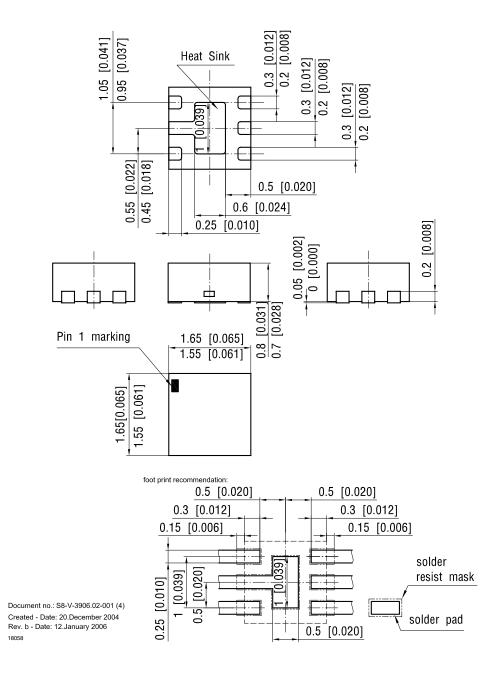




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